

Multilayer Ceramic Chip Capacitors

C3225X5R1E106K250AA



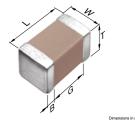






TDK item description C3225X5R1E106KT****

Applications	Commercial Grade
Feature	General General (Up to 50V)
Series	C3225 [EIA 1210]
Status	Production



9	Size
Length(L)	3.20mm ±0.40mm
Width(W)	2.50mm ±0.30mm
Thickness(T)	2.50mm ±0.30mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	2.00mm to 2.40mm
Recommended Land Pattern (PB)	1.00mm to 1.20mm
Recommended Land Pattern (PC)	1.90mm to 2.50mm

Electrical Characteristics		
Capacitance	10μF ±10%	
Rated Voltage	25VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	50ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

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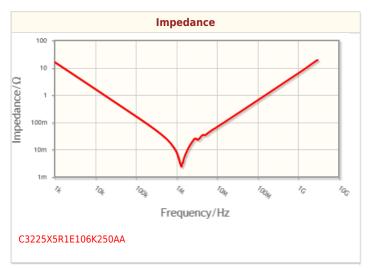


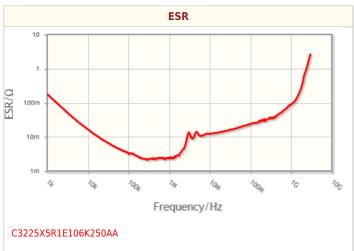


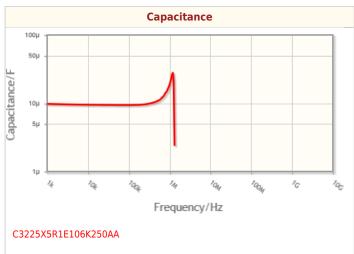


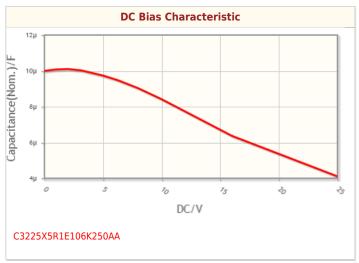


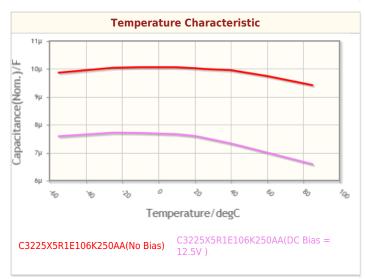
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

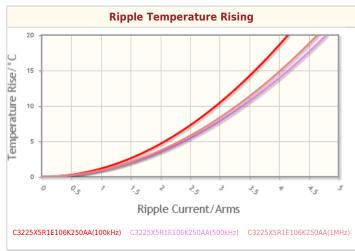












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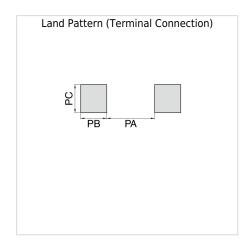








Associated Images



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